



### 3.2x2.4mm SMD CHIP LED LAMP

### **Features**

• Ideal for indication light on hand held products

www.SunLEDusa.com

• Long life and robust package

• Standard Package: 1,500pcs/ Reel

 $\bullet$  MSL (Moisture Sensitivity Level): 3

• RoHS compliant





## Package Schematics POLARITY MARK ø1.8[0.071] 2.2[0.087] P.C.BOARD 3.2[0.126] 2.1[0.083] 1.9[0.075] 1.8[0.071]

0.55[0.022]

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

2.1[0.083]

Absolute Maximum Ratings (T <sub>A</sub> =25°C)	M2ACR (AlGaInP)	Unit		
Reverse Voltage		5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	uty Cycle i <sub>FS</sub> 150		mA	
Power Dissipation	$P_{D}$	84	mW	
Operating Temperature	$T_{A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	C	

Operating Characteristics (T <sub>A</sub> =25°C)	M2ACR (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)		2.8	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λР	640*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	625*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	25	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	27	pF

Part Number	Emitting Color	Emitting Material	Lens-color	CIE127-2007* (I <sub>F</sub> =20mA) mcd	Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2

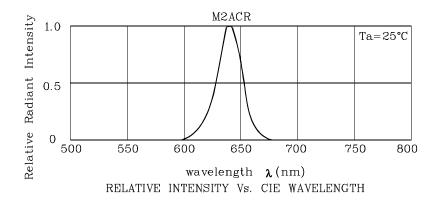
				min.	typ.		
XZM2ACR78W	Red	AlGaInP	Water Clear	7000 2700*	8990 3590*	640*	20°

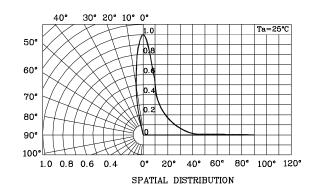
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Mar 25,2014

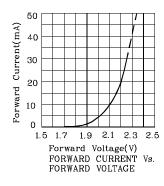


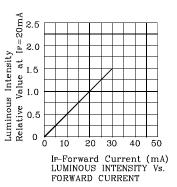


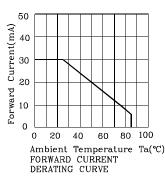


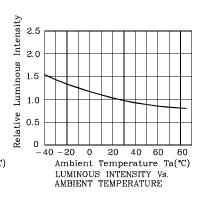


### **❖** M2ACR



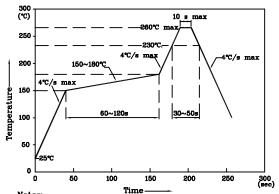






## LED is recommended for reflow soldering and soldering profile is shown below.

### Reflow Soldering Profile for SMD Products (Pb-Free Components)

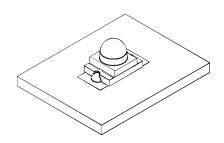


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

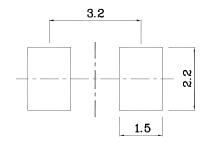




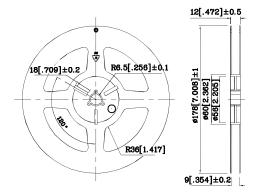
# ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



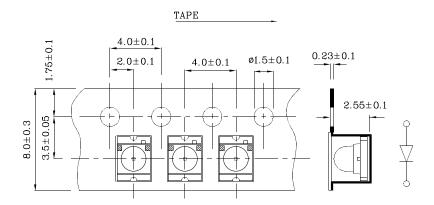
## **❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **❖** Reel Dimension



### \* Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

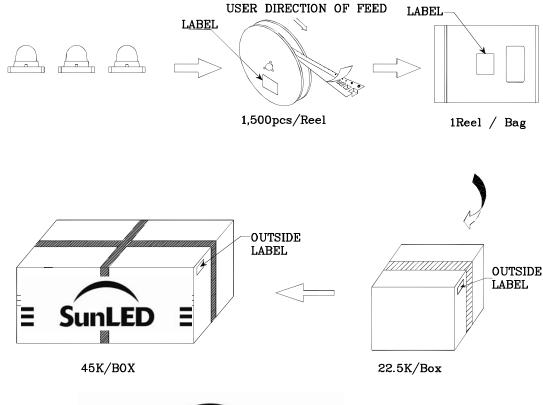
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

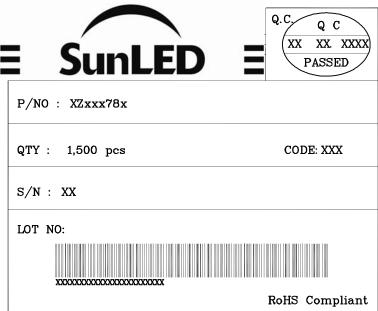
Note: Accuracy may depend on the sorting parameters.





### PACKING & LABEL SPECIFICATIONS





### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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